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March 2008

MM74HCT74
Dual D-Type Flip-Flop with Preset and Clear

Features

- Typical propagation delay: 20ns
- Low quiescent current: 40µA maximum (74HCT Series)
- Low input current: 1µA maximum
- Fanout of 10 LS-TTL loads
- Meta-stable hardened

General Description

The MM74HCT74 utilizes advanced silicon-gate CMOS technology to achieve operation speeds similar to the equivalent LS-TTL part. It possesses the high noise immunity and low power consumption of standard CMOS integrated circuits, along with the ability to drive 10 LS-TTL loads.

This flip-flop has independent data, preset, clear, and clock inputs and Q and $\overline{Q}$ outputs. The logic level present at the data input is transferred to the output during the positive-going transition of the clock pulse. Preset and clear are independent of the clock and accomplished by a low level at the appropriate input.

The 74HCT logic family is functionally and pin-out compatible with the standard 74LS logic family. All inputs are protected from damage due to static discharge by internal diode clamps to V_{CC} and ground.

MM74HCT devices are intended to interface between TTL and NMOS components and standard CMOS devices. These parts are also plug-in replacements for LS-TTL devices and can be used to reduce power consumption in existing designs.

Ordering Information

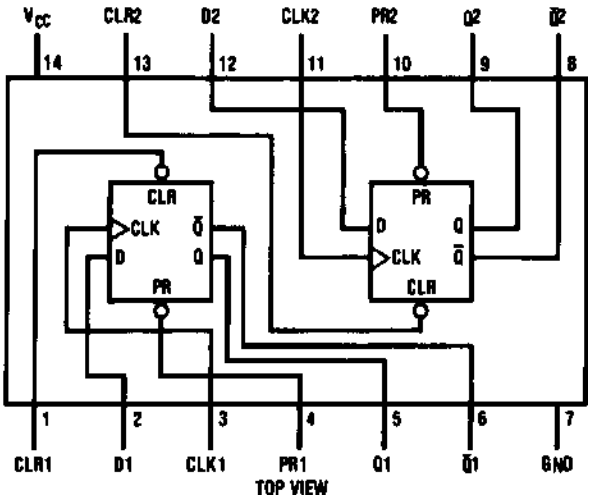
Order Number	Package Number	Package Description
MM74HCT74M	M14A	14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow
MM74HCT74SJ	M14D	14-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
MM74HCT74MTC	MTC14	14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide
MM74HCT74N	N14A	14-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide

Device also available in Tape and Reel. Specify by appending suffix letter “X” to the ordering number.

All packages are lead free per JEDEC: J-STD-020B standard.

Connection Diagram

Pin Assignments for DIP, SOIC, SOP and TSSOP



Truth Table

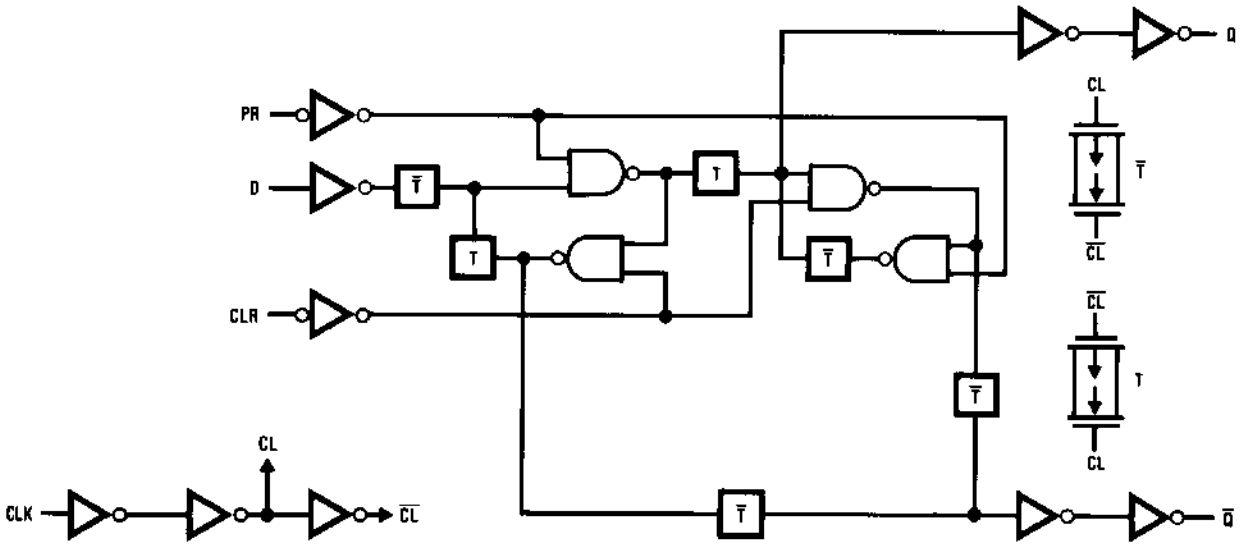
Inputs				Outputs	
PR	CLR	CLK	D	Q	$\overline{Q}$
L	H	X	X	H	L
H	L	X	X	L	H
L	L	X	X	H(1)	H(1)
H	H	↑	H	H	L
H	H	↑	L	L	H
H	H	L	X	Q0	$\overline{Q}$0

Q0 = the level of Q before the indicated input conditions were established.

Note:

1. This configuration is nonstable; that is, it will not persist when preset and clear inputs return to their inactive (HIGH) level.

Logic Diagram



Absolute Maximum Ratings(2)

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Rating
V_{CC}	Supply Voltage	–0.5 to +7.0V
V_{IN}	DC Input Voltage	–1.5 to V_{CC} +1.5V
V_{OUT}	DC Output Voltage	–0.5 to V_{CC} +0.5V
I_{IK}, I_{OK}	Clamp Diode Current	±20mA
I_{OUT}	DC Output Current, per pin	±25mA
I_{CC}	DC V_{CC} or GND Current, per pin	±50mA
T_{STG}	Storage Temperature Range	–65°C to +150°C
P_D	Power Dissipation Note 3 S.O. Package only	 600mW 500mW
T_L	Lead Temperature (Soldering 10 seconds)	260°C

Notes:

2. Unless otherwise specified all voltages are referenced to ground.
3. Power Dissipation temperature derating — plastic “N” package: –12 mW/°C from 65°C to 85°C.

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

Symbol	Parameter	Min.	Max.	Units
V_{CC}	Supply Voltage	4.5	5.5	V
V_{IN}, V_{OUT}	DC Input or Output Voltage	0	V_{CC}	V
T_A	Operating Temperature Range	–40	+85	°C
t_r, t_f	Input Rise or Fall Times		500	ns

DC Electrical Characteristics

V_{CC} = 5V ±10% (unless otherwise specified).

Symbol	Parameter	Conditions	T_A = 25°C Typ.	T_A = 25°C Guaranteed Limits	T_A = –40°C to 85°C Guaranteed Limits	T_A = –55°C to 125°C Guaranteed Limits	Units
V_{IH}	Minimum HIGH Level Input Voltage			2.0	2.0	2.0	V
V_{IL}	Maximum LOW Level Input Voltage			0.8	0.8	0.8	V
V_{OH}	Minimum HIGH Level Output Voltage	$V_{IN} = V_{IH}$ or V_{IL}, $\|I_{OUT}\| = 20\mu A$	V_{CC}	$V_{CC} - 0.1$	$V_{CC} - 0.1$	$V_{CC} - 0.1$	V
		$V_{IN} = V_{IH}$ or V_{IL}, $\|I_{OUT}\| = 4.0mA$, $V_{CC} = 4.5V$	4.2	3.98	3.84	3.7	
		$V_{IN} = V_{IH}$ or V_{IL}, $\|I_{OUT}\| = 4.8mA$, $V_{CC} = 5.5V$	5.2	4.98	4.84	4.7	
V_{OL}	Maximum LOW Level Voltage	$V_{IN} = V_{IH}$ or V_{IL}, $\|I_{OUT}\| = 20\mu A$	0	0.1	0.1	0.1	V
		$V_{IN} = V_{IH}$ or V_{IL}, $\|I_{OUT}\| = 4.0mA$, $V_{CC} = 4.5V$	0.2	0.26	0.33	0.4	
		$V_{IN} = V_{IH}$ or V_{IL}, $\|I_{OUT}\| = 4.8mA$, $V_{CC} = 5.5V$	0.2	0.26	0.33	0.4	
I_{IN}	Maximum Input Current	$V_{IN} = V_{CC}$ or GND, V_{IH} or V_{IL}		±0.5	±0.5	±1.0	µA
I_{CC}	Maximum Quiescent Supply Current	$V_{IN} = V_{CC}$ or GND, $I_{OUT} = 0\mu A$		2.0	20	80	µA
		V_{IN} = 2.4V or 0.5V(4)		0.3	0.4	0.5	mA

Note:

4. This is measured per pin. All other inputs are held at V_{CC} Ground.

AC Electrical Characteristics

V_{CC} = 5V, T_A = 25°C, C_L = 15 pF, $t_r = t_f$ = 6ns.

Symbol	Parameter	Conditions	Typ.	Guaranteed Limit	Units
f_{MAX}	Maximum Operating Frequency from Clock to Q or $\overline{Q}$		50	30	MHz
t_{PHL}, t_{PLH}	Maximum Propagation Delay Clock to Q or $\overline{Q}$		18	30	ns
t_{PHL}, t_{PLH}	Maximum Propagation Delay from Preset or Clear to Q or $\overline{Q}$		18	30	ns
t_{REM}	Minimum Removal Time, Preset or Clear to Clock			20	ns
t_S	Minimum Setup Time Data to Clock			20	ns
t_H	Minimum Hold Time Clock to Data		–3	0	ns
t_W	Minimum Pulse Width Clock, Preset or Clear		8	16	ns

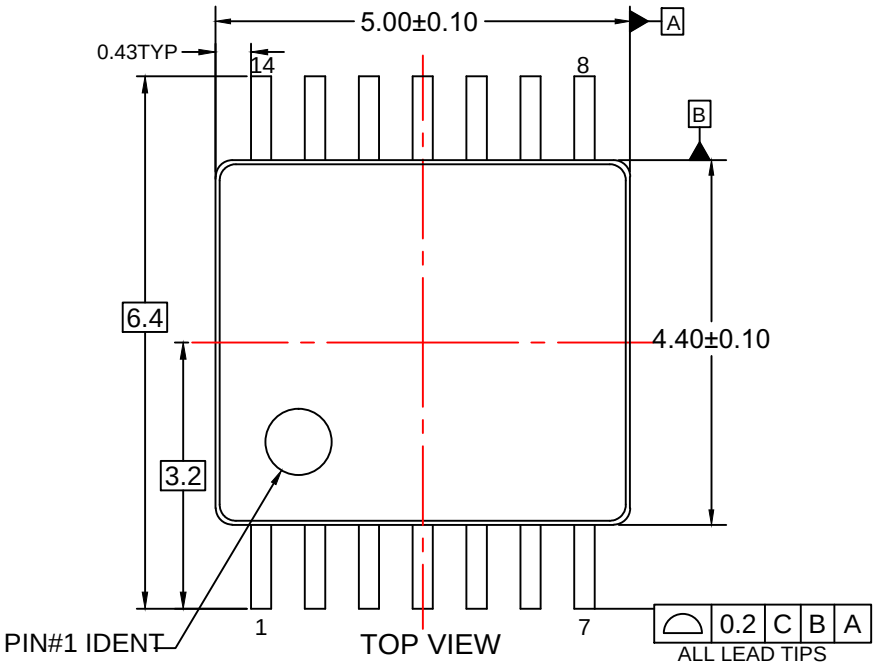
AC Electrical Characteristics

V_{CC} = 5.0V ± 10%, C_L = 50 pF, $t_r = t_f$ = 6ns unless otherwise specified.

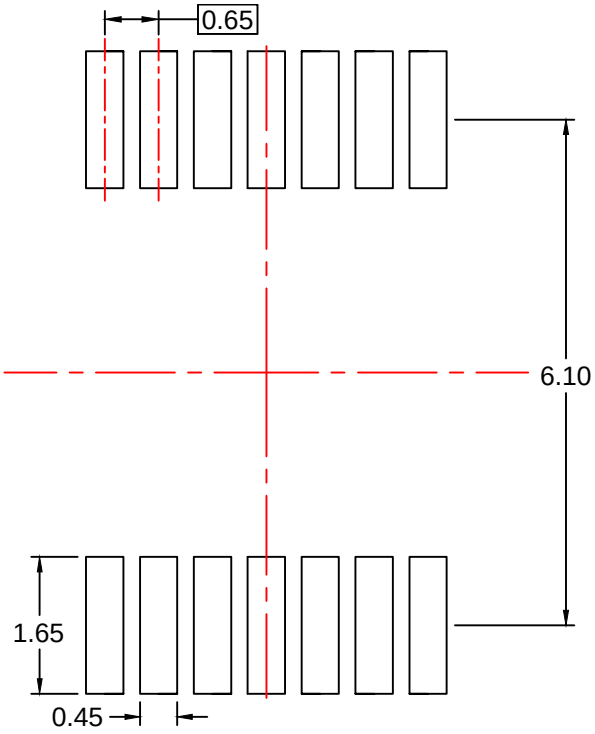
Symbol	Parameter	Conditions	T_A = 25°C	T_A = –40° to +85°C		Units
			Typ.	Guaranteed Limits		
f_{MAX}	Maximum Operating Frequency			27	21	MHz
t_{PHL}, t_{PLH}	Maximum Propagation Delay from Clock to Q or $\overline{Q}$		21	35	44	ns
t_{PHL}, t_{PLH}	Maximum Propagation Delay from Preset or Clear to Q or $\overline{Q}$		21	35	44	ns
t_{REM}	Minimum Removal Time Preset or Clear to Clock			20	25	ns
t_S	Minimum Setup Time Data to Clock			20	25	ns
t_H	Minimum Hold Time Clock to Data		–3	0	0	ns
t_W	Minimum Pulse Width Clock, Preset or Clear		9	16	20	ns
t_r, t_f	Maximum Clock Input Rise and Fall Time			500	500	ns
t_{THL}, t_{TLH}	Maximum Output Rise and Fall Time			15	19	ns
C_{PD}	Power Dissipation Capacitance(5)	(per flip-flop)	10			pF
C_{IN}	Maximum Input Capacitance		5	10	10	pF

Note:

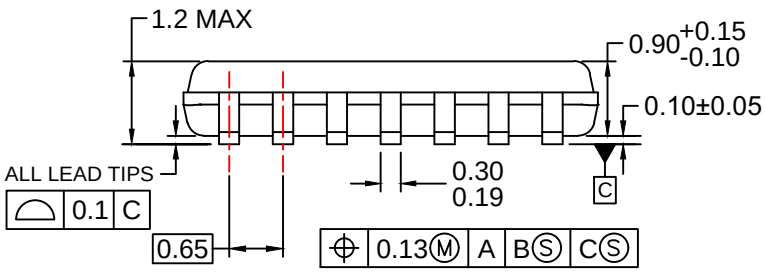
5. C_{PD} determines the no load dynamic power consumption, $P_D = C_{PD} V_{CC}^2 f + I_{CC} V_{CC}$, and the no load dynamic current consumption, $I_S = C_{PD} V_{CC} f + I_{CC}$.



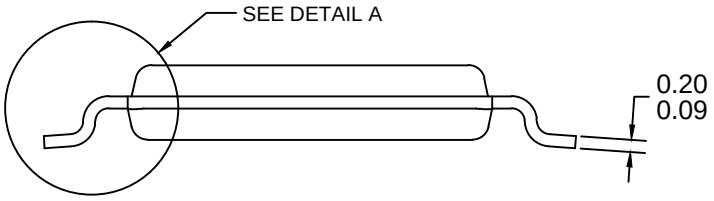
TOP VIEW

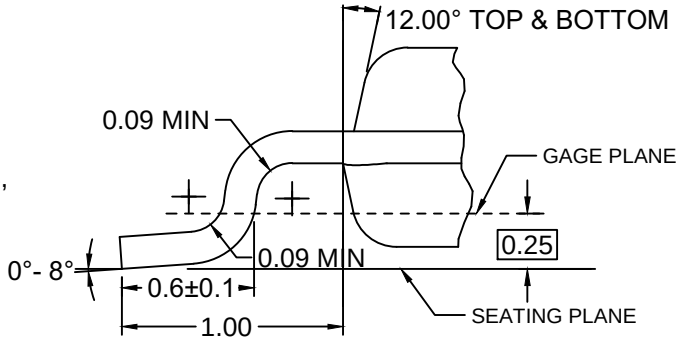


RECOMMENDED LAND PATTERN



FRONT VIEW





DETAIL A

NOTES:

A. CONFORMS TO JEDEC REGISTRATION MO-153, VARIATION AB, REF NOTE 6

B. DIMENSIONS ARE IN MILLIMETERS.

C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS

D. DIMENSIONING AND TOLERANCES PER ANSI Y14.5M, 2009.

E. LANDPATTERN STANDARD: SOP65P640X110-14M.

F. DRAWING FILE NAME: MKT-MTC14rev7.

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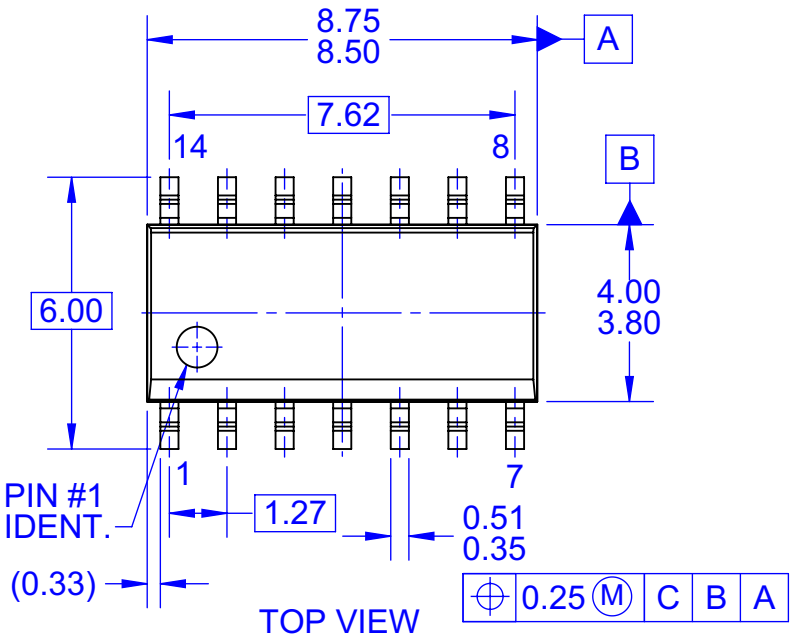
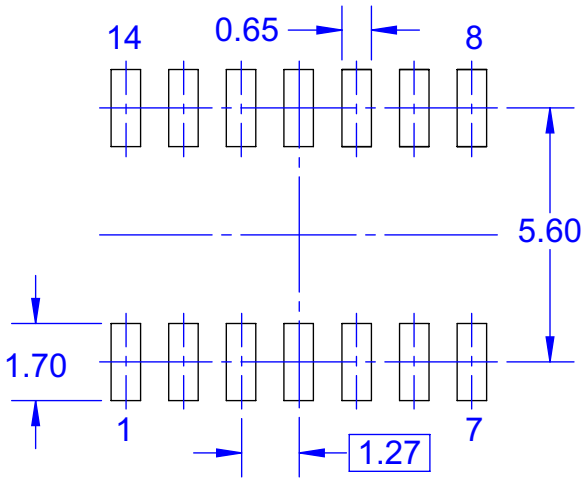
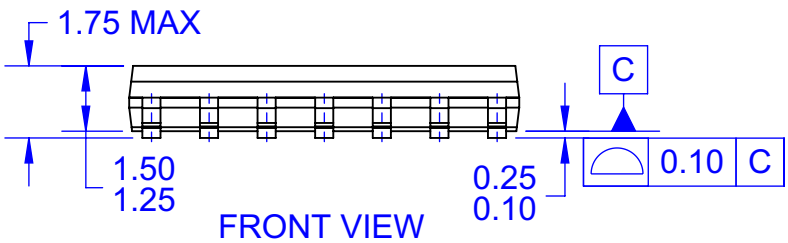


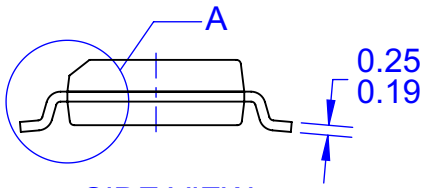
TOP VIEW



LAND PATTERN RECOMMENDATION



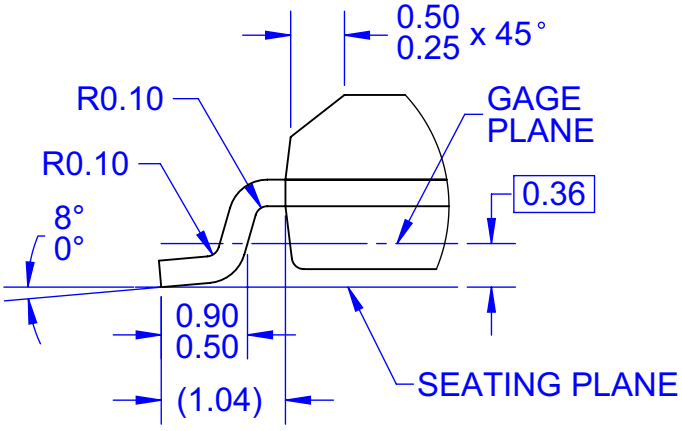
FRONT VIEW



SIDE VIEW

NOTES:

A. CONFORMS TO JEDEC MS-012, VARIATION AB, ISSUE C
B. ALL DIMENSIONS ARE IN MILLIMETERS
C. DIMENSIONS DO NOT INCLUDE MOLD FLASH OR BURRS
D. LAND PATTERN STANDARD: SOIC127P600X145-14M
E. CONFORMS TO ASME Y14.5M, 2009
D. DRAWING FILENAME: MKT-M14Arev14



DETAIL A
SCALE 16 : 1

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